

## HOW TO USE FORM

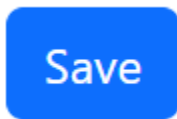
### Testing:

1. Fill up Form 1 Fields (“Done By - Testing” - “SDP”) as usual. Do not fill in “Done By - Tracing”.
2. Leave “Tracing” Field blank.

Tracing\*

Scan by Bar Code

3. Click the “Save” button once done.



### Tracing:

1. Key in “Split ID”, “Lot ID” & “Lot ID Suffix”.
2. Click the “Autofill” button to fill in inputs from testing.
  - a. Wait for 5 seconds for it to load. ⌚

Full Lot No (订单号)\*

Autofill

3. Fill in “Done By - Tracing”.

Tracing\*

Scan by Bar Code

4. Select necessary defect(s) from the dropdown(s).

Open Circuit Due To (开路原因)\*

Partial Feature (Blind Via Void)  
Lifted Feature (Circuit Peel-off)  
Missing Hole  
Outerlayer Open  
Mask on Pad/Finger  
Plating Nodule (Particle in Hole)  
Legend on Pad/Hole  
Others Open

Short Circuit Due To (短路原因)\*

Short (Plating Under Resist) (Dry Film Fl  
Scratches  
Cu Residue  
Under-etch  
Innerlayer Short  
Mis-registration  
Hole Shifted  
Short (Mirco-short)

Impedance Fail (阻抗失效)\*

☐ Yes

☐ No

Final Passed Qty (最终合格数量)\*

Save

Overview

Submit

5. Each selected defect will be displayed in a box below its respective dropdown.

Innerlayer Open

Qty Reject -

080 IL\_STRIP

X

6. To remove a defect, click the 'X' button at the top right.
7. Once done, click the "Submit" button.

## THINGS TO TAKE NOTE OF

Done By: Enter only **one Employee ID** for each field.

CCN: This is now under “Split ID”.

Lot ID: Note that this is solely for “Lot ID”. Do indicate “Split ID”, “Lot ID Suffix” and “For 4wire” in their respective fields.

Mfg Qty: Enter quantity specific to that lot if the lot is splitted up. Do not enter the total quantity of the entire lot.

Form 2 Fields: These will only appear when “Open” or “Short” have values more than 0.

Link to Form:

<https://script.google.com/macros/s/AKfycbwZy73ecorAlqLXE4Q29h8LACuyrfpd2jaR3IJmTwARdrpljfyghcdyOZ0T-ecBcwUf/exec>